Vishay Siliconix

# N-Channel 200 V (D-S) MOSFET



| PRODUCT SUMMARY  |        |  |  |  |  |  |
|--|--------|--|--|--|--|--|
| V <sub>DS</sub> (V)  | 200    |  |  |  |  |  |
| $R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$  | 0.070  |  |  |  |  |  |
| $R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 7.5 \text{ V}$ | 0.080  |  |  |  |  |  |
| Q <sub>g</sub> typ. (nC)                                   | 15     |  |  |  |  |  |
| I <sub>D</sub> (A) <sup>a</sup>                            | 17.2   |  |  |  |  |  |
| Configuration  | Single |  |  |  |  |  |

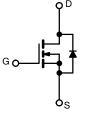
#### **FEATURES**

- $\bullet$  ThunderFET technology optimizes balance of  $R_{DS(\text{on})},\,Q_g,\,Q_{sw},$  and  $Q_{oss}$
- 100 % R<sub>q</sub> and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



### **APPLICATIONS**

- · Fixed telecom
- DC/DC converter
- · Primary and secondary side switch
- · Synchronous rectification



N-Channel MOSFET

| ORDERING INFORMATION            |                  |
|---------------------------------|------------------|
| Package                         | PowerPAK SO-8    |
| Lead (Pb)-free and halogen-free | Si7172ADP-T1-RE3 |

| PARAMETER   |   | SYMBOL                            | LIMIT  | UNIT |  |
|---|---|-----------------------------------|--|------|--|
| Drain-source voltage  |   | V <sub>DS</sub>                   | 200  | V    |  |
| Gate-source voltage   |   | V <sub>GS</sub>                   | ± 20   |      |  |
| Continuous drain current (T <sub>J</sub> = 150 °C)                        | $T_C = 25 ^{\circ}\text{C}$<br>$T_C = 70 ^{\circ}\text{C}$  |                                   | 17.2<br>13.8   |      |  |
|   | T <sub>A</sub> = 25 °C  | l <sub>D</sub>                    | 5.3 b, c<br>4.2 b, c                                 |      |  |
| $T_A = 70  ^{\circ}\text{C}$ Pulsed drain current (t = 100 $\mu$ s)       |   | I <sub>DM</sub>                   | 50   | A    |  |
| Continuous source-drain diode current                                     | $T_C = 25  ^{\circ}C$<br>$T_A = 25  ^{\circ}C$  | I <sub>S</sub>                    | 26<br>4.5 <sup>b, c</sup>                            |      |  |
| Single pulse avalanche current  Single pulse avalanche Energy  L = 0.1 mH |   | I <sub>AS</sub>                   | 15   |      |  |
|   |   | E <sub>AS</sub>                   | 11.25  | mJ   |  |
| Maximum power dissipation   | $T_{C} = 25  ^{\circ}\text{C}$ $T_{C} = 70  ^{\circ}\text{C}$ $T_{A} = 25  ^{\circ}\text{C}$ $T_{A} = 70  ^{\circ}\text{C}$ | P <sub>D</sub>                    | 52<br>33<br>5 <sup>b, c</sup><br>3.2 <sup>b, c</sup> | w    |  |
| Operating junction and storage temperature range                          |   | T <sub>J</sub> , T <sub>stg</sub> | -55 to +150  | °C   |  |
| Soldering recommendations (peak temperature                               |   | 260                               |  |      |  |

| THERMAL RESISTANCE RATINGS       |              |                   |         |         |      |
|----------------------------------|--------------|-------------------|---------|---------|------|
| PARAMETER                        |              | SYMBOL            | TYPICAL | MAXIMUM | UNIT |
| Maximum junction-to-ambient b, f | t ≤ 10 s     | R <sub>thJA</sub> | 20      | 25      | °C/W |
| Maximum junction-to-case (drain) | Steady state | $R_{thJC}$        | 1.9     | 2.4     | C/VV |

#### **Notes**

- a.  $T_C = 25 \,^{\circ}C$
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. See solder profile (<a href="www.vishay.com/doc?73257">www.vishay.com/doc?73257</a>). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- f. Maximum under steady state conditions is 65 °C/W

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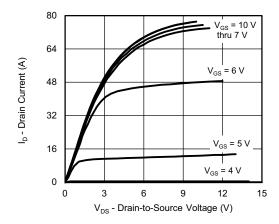
| PARAMETER                                     | SYMBOL                  | TEST CONDITIONS  | MIN. | TYP.  | MAX.  | UNIT |
|---|-------------------------|--|------|-------|-------|------|
| Static  |                         |  |      | 1     |       | ı    |
| Drain-source breakdown voltage                | $V_{DS}$                | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$  | 200  | -     | -     | V    |
| V <sub>DS</sub> temperature coefficient       | $\Delta V_{DS}/T_{J}$   |  | -    | 156   | -     | 140  |
| V <sub>GS(th)</sub> temperature coefficient   | $\Delta V_{GS(th)}/T_J$ | I <sub>D</sub> = 250 μA  | -    | -6.7  | -     | mV/° |
| Gate-source threshold voltage                 | V <sub>GS(th)</sub>     | $V_{DS} = V_{GS}, I_D = 250 \mu A$   | 2    | -     | 4     | V    |
| Gate-source leakage                           | I <sub>GSS</sub>        | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$  | -    | -     | ± 100 | nA   |
|   |                         | V <sub>DS</sub> = 200 V, V <sub>GS</sub> = 0 V   | -    | -     | 1     | μΑ   |
| Zero gate voltage drain current               | I <sub>DSS</sub>        | V <sub>DS</sub> = 200 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C                     | -    | -     | 10    |      |
| On-state drain current a                      | I <sub>D(on)</sub>      | $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$  | 30   | -     | -     | Α    |
|   | _ ` `                   | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 A  | -    | 0.050 | 0.070 |      |
| Drain-source on-state resistance <sup>a</sup> | R <sub>DS(on)</sub>     | $V_{GS} = 7.5 \text{ V}, I_D = 10 \text{ A}$   | -    | 0.051 | 0.080 | Ω    |
| Forward transconductance a                    | 9 <sub>fs</sub>         | V <sub>DS</sub> = 15 V, I <sub>D</sub> = 10 A  | -    | 26    | -     | S    |
| Dynamic <sup>b</sup>                          |                         |  |      |       |       |      |
| Input capacitance                             | C <sub>iss</sub>        |  | -    | 1110  | -     |      |
| Output capacitance                            | C <sub>oss</sub>        | V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V, f = 1 MHz                                  |      | 100   | -     | pF   |
| Reverse transfer capacitance                  | C <sub>rss</sub>        |  | _    | 8.3   | -     |      |
| ·   | $Q_g$                   | $V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$                        | -    | 19.5  | 30    |      |
| Total gate charge                             |                         |  | -    | 15    | 23    | nC   |
| Gate-source charge                            | Q <sub>qs</sub>         | $V_{DS} = 100 \text{ V}, V_{GS} = 7.5 \text{ V}, I_{D} = 10 \text{ A}$                     | _    | 5.3   | -     |      |
| Gate-drain charge                             | Q <sub>qd</sub>         |  | -    | 5.2   | -     |      |
| Output charge                                 | Q <sub>oss</sub>        | V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V   | -    | 36    | 54    |      |
| Gate resistance                               | Ra                      | f = 1 MHz  | 0.5  | 1.6   | 3.0   | Ω    |
| Turn-on delay time                            | t <sub>d(on)</sub>      |  | -    | 9     | 18    |      |
| Rise time                                     | t <sub>r</sub>          | $V_{DD} = 100 \text{ V}, R_L = 10 \Omega$  | -    | 18    | 36    | 1    |
| Turn-off delay time                           | t <sub>d(off)</sub>     | $I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$                           | -    | 16    | 32    |      |
| Fall time                                     | t <sub>f</sub>          |  | -    | 8     | 16    |      |
| Turn-on delay time                            | t <sub>d(on)</sub>      |  | -    | 11    | 22    | ns   |
| Rise time                                     | t <sub>r</sub>          | $V_{DD} = 100 \text{ V}, R_{I} = 10 \Omega$  | -    | 45    | 90    |      |
| Turn-off delay time                           | t <sub>d(off)</sub>     | $I_D \cong 10 \text{ A}, V_{GEN} = 7.5 \text{ V}, R_g = 1 \Omega$                          | -    | 15    | 30    |      |
| Fall time                                     | t <sub>f</sub>          |  | -    | 23    | 46    |      |
| <b>Drain-Source Body Diode Characteristic</b> | cs                      |  |      | 1     |       |      |
| Continuous source-drain diode current         | I <sub>S</sub>          | T <sub>C</sub> = 25 °C   | -    | -     | 26    |      |
| Pulse diode forward current (t = 100 μs)      | I <sub>SM</sub>         |  | -    | -     | 50    | A    |
| Body diode voltage                            | V <sub>SD</sub>         | I <sub>S</sub> = 5 A   | -    | 0.81  | 1.1   | V    |
| Body diode reverse recovery time              | t <sub>rr</sub>         | -  | -    | 126   | 252   | ns   |
| Body diode reverse recovery charge            | Q <sub>rr</sub>         | 1 40 A 11/11 400 A/ T 57.50  | -    | 360   | 720   | nC   |
| Reverse recovery fall time                    | ta                      | $I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$ | -    | 49    | -     |      |
| Reverse recovery rise time                    | t <sub>b</sub>          |  | -    | 77    | -     | ns   |

#### Notes

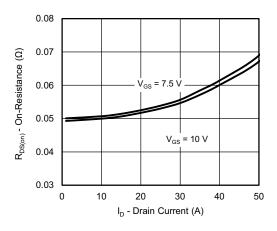
- a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

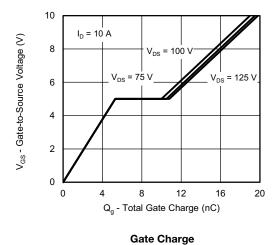


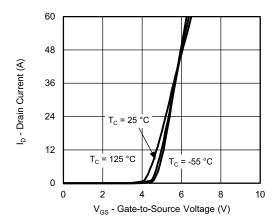


#### **Output Characteristics**

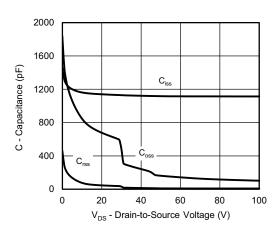


On-Resistance vs. Drain Current

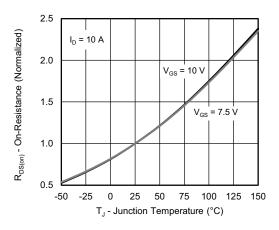




**Transfer Characteristics** 

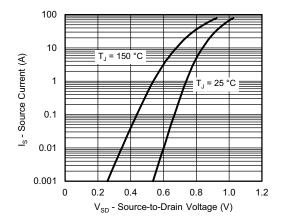


Capacitance

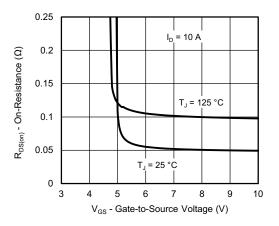


On-Resistance vs. Junction Temperature

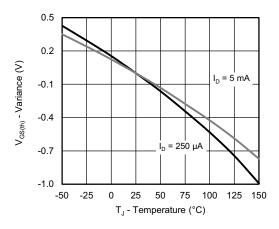




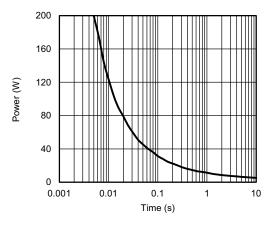
Source-Drain Diode Forward Voltage



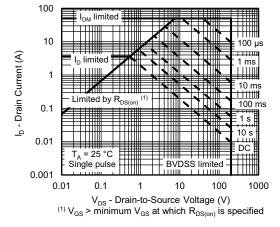
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 

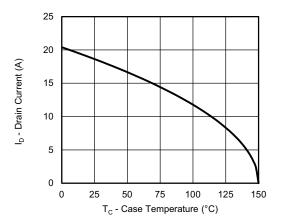


Single Pulse Power, Junction-to-Ambient

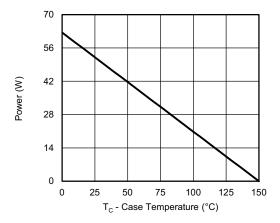


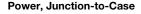
Safe Operating Area, Junction-to-Ambient

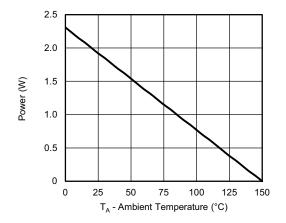




### Current Derating a





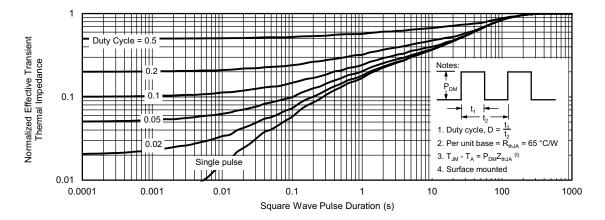


Power, Junction-to-Ambient

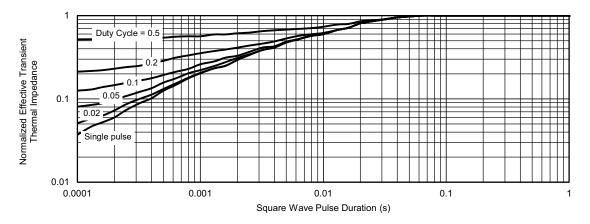
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





#### Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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# PowerPAK® SO-8, (Single/Dual)



| DIM. |            | MILLIMETERS |      |             | INCHES     |       |  |  |
|------|------------|-------------|------|-------------|------------|-------|--|--|
|      | MIN.       | NOM.        | MAX. | MIN.        | NOM.       | MAX   |  |  |
| Α    | 0.97       | 1.04        | 1.12 | 0.038       | 0.041      | 0.044 |  |  |
| A1   |            | -           | 0.05 | 0           | -          | 0.002 |  |  |
| b    | 0.33       | 0.41        | 0.51 | 0.013       | 0.016      | 0.020 |  |  |
| С    | 0.23       | 0.28        | 0.33 | 0.009       | 0.011      | 0.013 |  |  |
| D    | 5.05       | 5.15        | 5.26 | 0.199       | 0.203      | 0.207 |  |  |
| D1   | 4.80       | 4.90        | 5.00 | 0.189       | 0.193      | 0.197 |  |  |
| D2   | 3.56       | 3.76        | 3.91 | 0.140       | 0.148      | 0.154 |  |  |
| D3   | 1.32       | 1.50        | 1.68 | 0.052       | 0.059      | 0.066 |  |  |
| D4   |            | 0.57 typ.   |      | 0.0225 typ. |            |       |  |  |
| D5   |            | 3.98 typ.   |      | 0.157 typ.  |            |       |  |  |
| E    | 6.05       | 6.15        | 6.25 | 0.238       | 0.242      | 0.246 |  |  |
| E1   | 5.79       | 5.89        | 5.99 | 0.228       | 0.232      | 0.236 |  |  |
| E2   | 3.48       | 3.66        | 3.84 | 0.137       | 0.144      | 0.151 |  |  |
| E3   | 3.68       | 3.78        | 3.91 | 0.145       | 0.149      | 0.154 |  |  |
| E4   |            | 0.75 typ.   |      | 0.030 typ.  |            |       |  |  |
| е    |            | 1.27 BSC    |      |             | 0.050 BSC  |       |  |  |
| K    |            | 1.27 typ.   |      |             | 0.050 typ. |       |  |  |
| K1   | 0.56       | -           | -    | 0.022       | -          | -     |  |  |
| Н    | 0.51       | 0.61        | 0.71 | 0.020       | 0.024      | 0.028 |  |  |
| L    | 0.51       | 0.61        | 0.71 | 0.020       | 0.024      | 0.028 |  |  |
| L1   | 0.06       | 0.13        | 0.20 | 0.002       | 0.005      | 0.008 |  |  |
| θ    | 0°         | =           | 12°  | 0°          | -          | 12°   |  |  |
| W    | 0.15       | 0.25        | 0.36 | 0.006       | 0.010      | 0.014 |  |  |
| M    | 0.125 typ. |             |      | 0.005 typ.  |            |       |  |  |

Revison: 13-Feb-17 1 Document Number: 71655



## RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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